Octal Buffer/Line Driver with 3-State Outputs

The SN74LS240 and SN74LS244 are Octal Buffers and Line Drivers designed to be employed as memory address drivers, clock drivers and bus-oriented transmitters/receivers which provide improved PC board density.

- Hysteresis at Inputs to Improve Noise Margins
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Input Clamp Diodes Limit High-Speed Termination Effects



Symbol	Parameter	Min	Тур	Max	Unit
V _{CC}	Supply Voltage	4.75	5.0	5.25	V
T _A	Operating Ambient Temperature Range	0	25	70	°C
I _{OH}	Output Current – High			-3.0	mA
				-15	mA
I _{OL}	Output Current – Low			24	mA



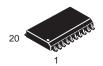
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LOW POWER SCHOTTKY



PLASTIC N SUFFIX CASE 738



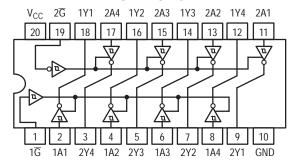
SOIC DW SUFFIX CASE 751D

ORDERING INFORMATION

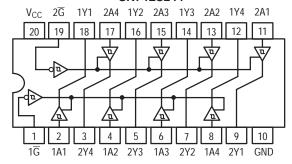
Device	Package	Shipping
SN74LS240N	16 Pin DIP	1440 Units/Box
SN74LS240DW	16 Pin	2500/Tape & Reel
SN74LS244N	16 Pin DIP	1440 Units/Box
SN74LS244DW	16 Pin	2500/Tape & Reel

LOGIC AND CONNECTION DIAGRAMS DIP (TOP VIEW)

SN74LS240



SN74LS244



TRUTH TABLES

SN74LS240

INP	OUTPUT	
1 G , 2 G	OUIPUI	
L	L	Н
L	Н	L
Н	X	(Z)

SN74LS244

INP	OUTPUT	
1G, 2G	OUTPUT	
L	L	L
L	Н	Н
Н	Х	(Z)

H = HIGH Voltage Level L = LOW Voltage Level X = Immaterial Z = HIGH Impedance

DC CHARACTERISTICS OVER OPERATING TEMPERATURE RANGE (unless otherwise specified)

			Limits					
Symbol	Paramete		Min	Тур	Max	Unit	Test	Conditions
V _{IH}	Input HIGH Voltage		2.0			٧	Guaranteed Input HIGH Voltage for All Inputs	
V _{IL}	Input LOW Voltage				0.8	V	Guaranteed Input LOW Voltage for All Inputs	
$V_{T+}-V_{T-}$	Hysteresis		0.2	0.4		V	V _{CC} = MIN	
V_{IK}	Input Clamp Diode Volt	age		-0.65	-1.5	V	V _{CC} = MIN, I _{IN} =	−18 mA
Vari	Output HIGH Voltage		2.4	3.4		V	V _{CC} = MIN, I _{OH} =	= -3.0 mA
V _{OH}	Output HIGH Voltage		2.0			V	V _{CC} = MIN, I _{OH} = MAX	
.,				0.25	0.4	V	I _{OL} = 12 mA	$V_{CC} = V_{CC} MIN,$
V _{OL} Output LOW Voltage				0.35	0.5	٧	I _{OL} = 24 mA	V _{IN} = V _{IL} or V _{IH} per Truth Table
I _{OZH}	Output Off Current HIGH				20	μΑ	V _{CC} = MAX, V _{OUT} = 2.7 V	
I _{OZL}	Output Off Current LOW				-20	μΑ	V _{CC} = MAX, V _{OUT} = 0.4 V	
	In part I II Cl I Carront				20	μΑ	$V_{CC} = MAX, V_{IN}$	= 2.7 V
l _{IH}	Input HIGH Current				0.1	mA	V _{CC} = MAX, V _{IN} = 7.0 V	
I _{IL}	Input LOW Current				-0.2	mA	V _{CC} = MAX, V _{IN} = 0.4 V	
I _{OS}	Output Short Circuit Current (Note 1)		-40		-225	mA	V _{CC} = MAX	
	Power Supply Current Total, Output HIGH				27			
lcc	Total, Output LOW	LS240			44	1		
		LS244			46	mA	mA V _{CC} = MAX	
		LS240			50	1		
		LS244			54	1		

Note 1: Not more than one output should be shorted at a time, nor for more than 1 second.

AC CHARACTERISTICS ($T_A = 25^{\circ}C$, $V_{CC} = 5.0 \text{ V}$)

		Limits				
Symbol	Parameter	Min	Тур	Max	Unit	Test Conditions
t _{PLH} t _{PHL}	Propagation Delay, Data to Output LS240		9.0 12	14 18	ns	
t _{PLH} t _{PHL}	Propagation Delay, Data to Output LS244		12 12	18 18	ns	$C_L = 45 \text{ pF},$ $R_L = 667 \Omega$
t _{PZH}	Output Enable Time to HIGH Level		15	23	ns	
t _{PZL}	Output Enable Time to LOW Level		20	30	ns	
t _{PLZ}	Output Disable Time from LOW Level		15	25	ns	$C_L = 5.0 \text{ pF},$
t _{PHZ}	Output Disable Time from HIGH Level		10	18	ns	$R_L = 667 \Omega$

AC WAVEFORMS

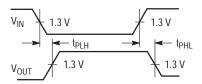


Figure 1.

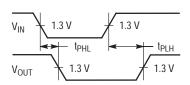


Figure 2.

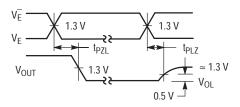


Figure 3.

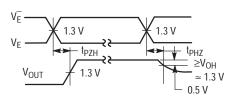
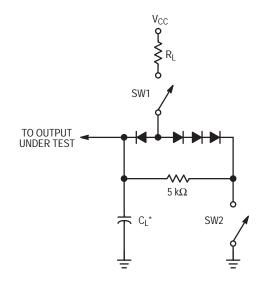


Figure 4.



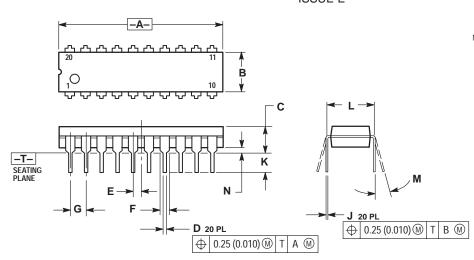
SWITCH POSITIONS

SYMBOL	SW1	SW2
t _{PZH}	Open	Closed
t _{PZL}	Closed	Open
t _{PLZ}	Closed	Closed
t _{PHZ}	Closed	Closed

Figure 5.

PACKAGE DIMENSIONS

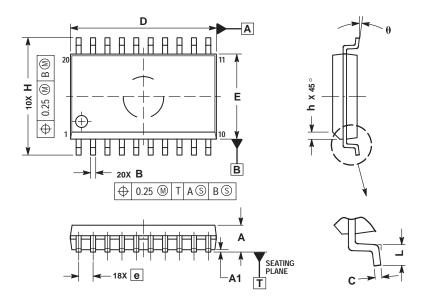
N SUFFIX PLASTIC PACKAGE CASE 738-03 ISSUE E



- NOTES:
 1. DIMENSIONING AND TOLERANCING PER ANSI Y14.5M, 1982.
 2. CONTROLLING DIMENSION: INCH.
 3. DIMENSION L TO CENTER OF LEAD WHEN FORMED PARALLEL.
 4. DIMENSION B DOES NOT INCLUDE MOLD FLASH.

	INC	HES	MILLIN	IETERS	
DIM	MIN	MAX	MIN	MAX	
Α	1.010	1.070	25.66	27.17	
В	0.240	0.260	6.10	6.60	
С	0.150	0.180	3.81	4.57	
D	0.015 0.022		0.39	0.55	
E	0.050	BSC	1.27 BSC		
F	0.050	0.070	1.27	1.77	
G	0.100	BSC	2.54	BSC	
J	0.008	0.015	0.21	0.38	
K	0.110	0.140	2.80	3.55	
L	0.300	BSC	7.62	BSC	
M	0 °	15°	0°	15°	
N	0.020	0.040	0.51	1.01	

D SUFFIX PLASTIC SOIC PACKAGE CASE 751D-05 ISSUE F



NOTES:

- NOTES:

 1. DIMENSIONS ARE IN MILLIMETERS.
 2. INTERPRET DIMENSIONS AND TOLERANCES PER ASME Y14.5M, 1994.
 3. DIMENSIONS D AND E DO NOT INCLUDE MOLD PROTRUSION.
 4. MAXIMUM MOLD PROTRUSION 0.15 PER SIDE.
 5. DIMENSION B DOES NOT INCLUDE DAMBAR PROTRUSION. ALLOWABLE PROTRUSION SHALL BE 0.13 TOTAL IN EXCESS OF B DIMENSION AT MAXIMUM MATERIAL CONDITION.

	MILLIMETERS				
DIM	MIN	MAX			
Α	2.35	2.65			
A1	0.10	0.25			
В	0.35	0.49			
С	0.23	0.32			
D	12.65	12.95			
Ε	7.40	7.60			
е	1.27 BSC				
Н	10.05	10.55			
h	0.25	0.75			
L	0.50	0.90			
θ	0°	7 °			



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